

Electronic Patent Application Fee Transmittal

Application Number:	10530713			
Filing Date:	16-Sep-2005			
Title of Invention:	MOLDING METHOD AND RESIN MOLDINGS			
First Named Inventor/Applicant Name:	Tomoyuki Obara			
Filer:	Marvin Jay Spivak/Mimi Chanthaphone			
Attorney Docket Number:	270450US0PCT			
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